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**Information technology —  
Telecommunications and information  
exchange between systems — Local and  
metropolitan area networks — Specific  
requirements —**

**Part 11:  
Wireless LAN medium access control  
(MAC) and physical layer (PHY)  
specifications**

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**AMENDMENT 3: Enhancements for very  
high throughput in the 60 GHz band  
(adoption of IEEE Std 802.11ad-2012)**

*Technologies de l'information — Télécommunications et échange  
d'information entre systèmes — Réseaux locaux et métropolitains —  
Exigences spécifiques —*

*Partie 11: Spécifications du contrôle d'accès du milieu sans fil (MAC) et  
de la couche physique (PHY)*

*AMENDEMENT 3: Améliorations pour un très haut débit de traitement  
dans la bande de fréquence 60 GHz (adoption de la norme IEEE Std  
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